

# N-Channel 40 V (D-S) MOSFET

| PRODUCT SUMMARY     |  |                                 |                       |  |  |  |  |  |  |
|---------------------|--|---------------------------------|-----------------------|--|--|--|--|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}\left(\Omega\right)$ (Max.) | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |  |  |  |  |
| 40                  | 0.026 at V <sub>GS</sub> = 10 V        | 12                              |                       |  |  |  |  |  |  |
|                     | 0.028 at V <sub>GS</sub> = 4.5 V       | 12                              | 6.9 nC                |  |  |  |  |  |  |
|                     | 0.029 at V <sub>GS</sub> = 3.7 V       | 12                              | 0.9110                |  |  |  |  |  |  |
|                     | 0.035 at V <sub>GS</sub> = 2.5 V       | 12                              |                       |  |  |  |  |  |  |

PowerPAK SC-70-6L-Single

# **FEATURES**

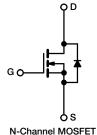
- TrenchFET® Power MOSFET
- 100 %  $R_{\alpha}$  and UIS Tested
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912



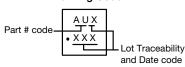
HALOGEN FREE

### **APPLICATIONS**

- · Portable Devices such as Tablet PCs and Mobile Computing
  - DC/DC Converter
  - Boost Converter
  - Load Switch
  - Power Management
  - LED Backlighting



### Marking Code



| $\bigwedge$          |             |
|----------------------|-------------|
|                      |             |
|                      |             |
|                      | G           |
| 5000                 | 2.05 mm     |
| 2.05 mm 4S)          | /           |
| rdering Information: | Bottom View |
| rdering information: |             |

SiA440DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter  |                                   | Symbol           | Limit                 | Unit   |  |  |
|--|-----------------------------------|------------------|-----------------------|--|--|--|
| Drain-Source Voltage                               |                                   | V <sub>DS</sub>  | 40                    | V  |  |  |
| Gate-Source Voltage                                |                                   | V <sub>GS</sub>  | ± 12                  | <b>一                                    </b> |  |  |
|  | T <sub>C</sub> = 25 °C            |                  | 12 <sup>a</sup>       |  |  |  |
| Continuous Drain Current /T 150 °C)                | T <sub>C</sub> = 70 °C            |                  | 12 <sup>a</sup>       |  |  |  |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | T <sub>A</sub> = 25 °C            | I <sub>D</sub>   | 8.6 <sup>a,b, c</sup> |  |  |  |
|  | T <sub>A</sub> = 70 °C            |                  | 6.9 <sup>b, c</sup>   |  |  |  |
| Pulsed Drain Current (t = 100 μs)                  | •                                 | I <sub>DM</sub>  | 50                    | A  |  |  |
| Continuous Course Drain Diada Current              | T <sub>C</sub> = 25 °C            |                  | 12 <sup>a</sup>       |  |  |  |
| Continuous Source-Drain Diode Current              | T <sub>A</sub> = 25 °C            | l <sub>s</sub> — | 2.9 <sup>b, c</sup>   |  |  |  |
| Single Avalanche Current                           | L = 0.1 mH                        | I <sub>AS</sub>  | 11                    |  |  |  |
| Single Avalanche Energy                            | L = 0.1 IIII                      | E <sub>AS</sub>  | 6                     | mJ   |  |  |
|  | T <sub>C</sub> = 25 °C            |                  | 19                    |  |  |  |
| Mariana Parray Dissipation                         | T <sub>C</sub> = 70 °C            | В                | 12                    | 147  |  |  |
| Maximum Power Dissipation                          | T <sub>A</sub> = 25 °C            | P <sub>D</sub>   | 3.5 <sup>b, c</sup>   | W  |  |  |
|  | T <sub>A</sub> = 70 °C            |                  | 2.2 <sup>b, c</sup>   |  |  |  |
| Operating Junction and Storage Temperature Ra      | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150      | °C                    |  |  |  |
| Soldering Recommendations (Peak Temperature        |                                   | 260              |                       |  |  |  |

| THERMAL RESISTANCE RATINGS                  |                                      |                   |         |      |              |  |  |  |
|---|--------------------------------------|-------------------|---------|------|--------------|--|--|--|
| Parameter                                   | Symbol                               | Typical           | Maximum | Unit |              |  |  |  |
| Maximum Junction-to-Ambient <sup>b, f</sup> | t ≤ 5 s R <sub>thJA</sub> 28 36 °C/M |                   | °C/W    |      |              |  |  |  |
| Maximum Junction-to-Case (Drain)            | Steady State                         | R <sub>thJC</sub> | 5.3     | 6.5  | O/ <b>VV</b> |  |  |  |

### Notes:

- a. Based on package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- $d. \ See \ solder \ profile \ (\underline{www.vishay.com/doc?73257}). \ The \ PowerPAK \ SC-70 \ is \ a \ leadless \ package. \ The \ end \ of \ the \ lead \ terminal \ is \ exposed \ copper \ package.$ (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 80 °C/W.



| <b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted |                         |   |      |       |       |        |  |  |  |
|---|-------------------------|---|------|-------|-------|--------|--|--|--|
| Parameter   | Symbol                  | Test Conditions   | Min. | Тур.  | Max.  | Unit   |  |  |  |
| Static  |                         |   |      |       |       |        |  |  |  |
| Drain-Source Breakdown Voltage  | $V_{DS}$                | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$   | 40   |       |       | V      |  |  |  |
| V <sub>DS</sub> Temperature Coefficient                               | $\Delta V_{DS}/T_{J}$   | I <sub>D</sub> = 250 μA   |      | 39    |       | m\//°C |  |  |  |
| V <sub>GS(th)</sub> Temperature Coefficient                           | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA   |      | - 3.6 |       | mV/°C  |  |  |  |
| Gate-Source Threshold Voltage   | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$  | 0.6  |       | 1.4   | V      |  |  |  |
| Gate-Source Leakage   | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$   |      |       | ± 100 | nA     |  |  |  |
| Zava Cata Valtaga Drain Current                                       | ı                       | V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V   |      |       | 1     | μΑ     |  |  |  |
| Zero Gate Voltage Drain Current                                       | IDSS                    | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$                |      |       | 10    |        |  |  |  |
| On-State Drain Current <sup>a</sup>                                   | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$   | 10   |       |       | Α      |  |  |  |
|   |                         | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A  |      | 0.021 | 0.026 |        |  |  |  |
|   |                         | $V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$   |      | 0.022 | 0.028 | Ω      |  |  |  |
| Drain-Source On-State Resistance <sup>a</sup>                         | R <sub>DS(on)</sub>     | $V_{GS} = 3.7 \text{ V}, I_D = 7 \text{ A}$   |      | 0.023 | 0.029 |        |  |  |  |
|   |                         | V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 7 A   |      | 0.026 | 0.035 |        |  |  |  |
| Forward Transconductance <sup>a</sup>                                 | 9 <sub>fs</sub>         | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 9 A  |      | 45    |       | S      |  |  |  |
| Dynamic <sup>b</sup>  |                         |   | l    |       | l     |        |  |  |  |
| Input Capacitance   | C <sub>iss</sub>        |   | 1    | 700   |       | pF     |  |  |  |
| Output Capacitance  | C <sub>oss</sub>        | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                          |      | 87    |       |        |  |  |  |
| Reverse Transfer Capacitance  | C <sub>rss</sub>        |   |      | 40    |       |        |  |  |  |
| ·   |                         | V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A                      |      | 14.3  | 21.5  | nC     |  |  |  |
| Total Gate Charge   | $Q_g$                   |   |      | 6.9   | 10.5  |        |  |  |  |
| Gate-Source Charge  | $Q_{gs}$                | $V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 9 \text{ A}$                        |      | 1.4   |       |        |  |  |  |
| Gate-Drain Charge   | $Q_{gd}$                |   |      | 2     |       | 1      |  |  |  |
| Gate Resistance   | $R_{g}$                 | f = 1 MHz   | 0.2  | 1     | 2     | Ω      |  |  |  |
| Turn-On Delay Time  | t <sub>d(on)</sub>      |   |      | 7     | 15    |        |  |  |  |
| Rise Time   | t <sub>r</sub>          | $V_{DD}$ = 20 V, $R_L$ = 2.9 $\Omega$   |      | 5     | 10    |        |  |  |  |
| Turn-Off Delay Time   | t <sub>d(off)</sub>     | $I_D \cong 7 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$                           |      | 20    | 40    | 1      |  |  |  |
| Fall Time   | t <sub>f</sub>          |   |      | 3     | 10    |        |  |  |  |
| Turn-On Delay Time  | t <sub>d(on)</sub>      |   |      | 12    | 25    | ns     |  |  |  |
| Rise Time   | t <sub>r</sub>          | $V_{DD}$ = 20 V, $R_L$ = 2.9 $\Omega$   |      | 32    | 65    |        |  |  |  |
| Turn-Off Delay Time   | t <sub>d(off)</sub>     | $I_D\cong 7$ A, $V_{GEN}=4.5$ V, $R_g=1$ $\Omega$   |      | 23    | 45    |        |  |  |  |
| Fall Time   | t <sub>f</sub>          |   |      | 5     | 10    |        |  |  |  |
| Drain-Source Body Diode Characteristic                                | s                       |   |      |       |       |        |  |  |  |
| Continuous Source-Drain Diode Current                                 | I <sub>S</sub>          | T <sub>C</sub> = 25 °C  |      |       | 12    | Λ      |  |  |  |
| Pulse Diode Forward Current (t = 100 μs)                              | I <sub>SM</sub>         |   |      |       | 50    | A      |  |  |  |
| Body Diode Voltage  | V <sub>SD</sub>         | I <sub>S</sub> = 7 A  |      | 0.85  | 1.2   | V      |  |  |  |
| Body Diode Reverse Recovery Time                                      | t <sub>rr</sub>         |   |      | 15    | 30    | ns     |  |  |  |
| Body Diode Reverse Recovery Charge                                    | Q <sub>rr</sub>         | L = 7 A dl/dt = 100 A/va T = 05 °C  |      | 7.5   | 15    | nC     |  |  |  |
| Reverse Recovery Fall Time  | t <sub>a</sub>          | $I_F = 7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ |      | 9     |       | 1      |  |  |  |
| Reverse Recovery Rise Time  | t <sub>b</sub>          |   |      | 6     |       | ns     |  |  |  |

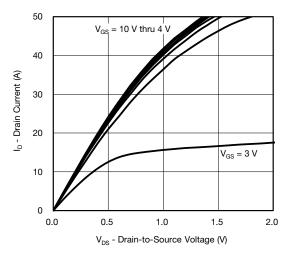
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

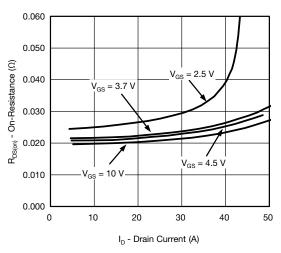
b. Guaranteed by design, not subject to production testing.



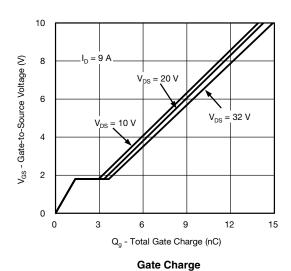
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

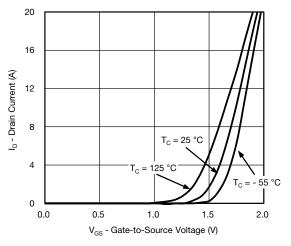


## **Output Characteristics**

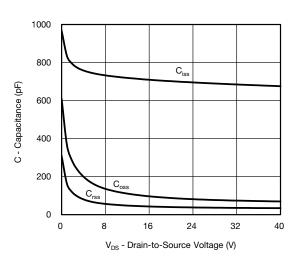


### On-Resistance vs. Drain Current and Gate Voltage

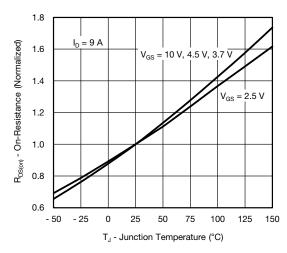




### **Transfer Characteristics**



### Capacitance



**On-Resistance vs. Junction Temperature** 

I<sub>D</sub> = 9 A

 $T_J = 25 \, ^{\circ}C$ 

6

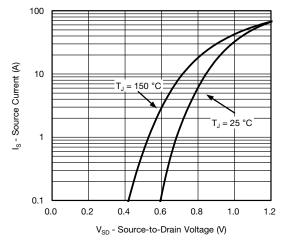
V<sub>GS</sub> - Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage

 $T_J = 125$  °C

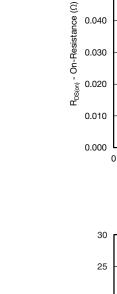
8

10

# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Source-Drain Diode Forward Voltage

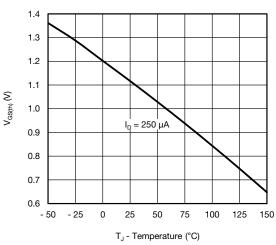


0.060

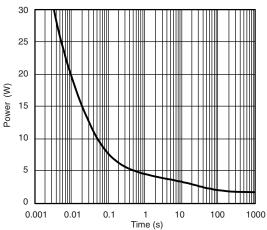
0.050

0.040

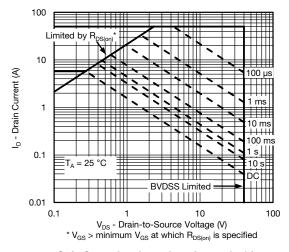
2



**Threshold Voltage** 



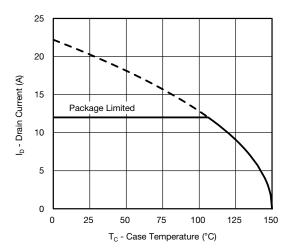
Single Pulse Power, Junction-to-Ambient



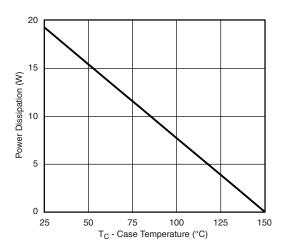
Safe Operating Area, Junction-to-Ambient



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



### **Current Derating\***

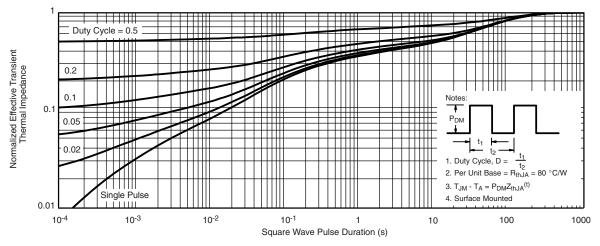


Power, Junction-to-Case

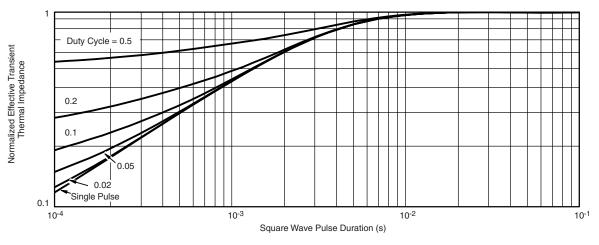
 $<sup>^*</sup>$  The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 150  $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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# PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
  Package outline exclusive of mold flash and metal burr
  Package outline inclusive of plating

|     | SINGLE PAD |           |                       |           |           |           | DUAL PAD  |           |           |           |       |       |
|-----|------------|-----------|-----------------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-------|-------|
| DIM | M          | ILLIMETER | RS INCHES MILLIMETERS |           | RS        | INCHES    |           |           |           |           |       |       |
|     | Min        | Nom       | Max                   | Min       | Nom       | Max       | Min       | Nom       | Max       | Min       | Nom   | Max   |
| Α   | 0.675      | 0.75      | 0.80                  | 0.027     | 0.030     | 0.032     | 0.675     | 0.75      | 0.80      | 0.027     | 0.030 | 0.032 |
| A1  | 0          | -         | 0.05                  | 0         | -         | 0.002     | 0         | -         | 0.05      | 0         | -     | 0.002 |
| b   | 0.23       | 0.30      | 0.38                  | 0.009     | 0.012     | 0.015     | 0.23      | 0.30      | 0.38      | 0.009     | 0.012 | 0.015 |
| С   | 0.15       | 0.20      | 0.25                  | 0.006     | 0.008     | 0.010     | 0.15      | 0.20      | 0.25      | 0.006     | 0.008 | 0.010 |
| D   | 1.98       | 2.05      | 2.15                  | 0.078     | 0.081     | 0.085     | 1.98      | 2.05      | 2.15      | 0.078     | 0.081 | 0.085 |
| D1  | 0.85       | 0.95      | 1.05                  | 0.033     | 0.037     | 0.041     | 0.513     | 0.613     | 0.713     | 0.020     | 0.024 | 0.028 |
| D2  | 0.135      | 0.235     | 0.335                 | 0.005     | 0.009     | 0.013     |           |           |           |           |       |       |
| Е   | 1.98       | 2.05      | 2.15                  | 0.078     | 0.081     | 0.085     | 1.98      | 2.05      | 2.15      | 0.078     | 0.081 | 0.085 |
| E1  | 1.40       | 1.50      | 1.60                  | 0.055     | 0.059     | 0.063     | 0.85      | 0.95      | 1.05      | 0.033     | 0.037 | 0.041 |
| E2  | 0.345      | 0.395     | 0.445                 | 0.014     | 0.016     | 0.018     |           |           |           |           |       |       |
| E3  | 0.425      | 0.475     | 0.525                 | 0.017     | 0.019     | 0.021     |           |           |           |           |       |       |
| е   |            | 0.65 BSC  |                       |           | 0.026 BSC | ;         | 0.65 BSC  |           |           | 0.026 BSC |       |       |
| K   |            | 0.275 TYP |                       |           | 0.011 TYP | 1         | 0.275 TYP |           | 0.011 TYP |           |       |       |
| K1  |            | 0.400 TYP |                       |           | 0.016 TYP |           | 0.320 TYP |           | 0.013 TYP |           |       |       |
| K2  |            | 0.240 TYP |                       | 0.009 TYP |           | 0.252 TYP |           | 0.010 TYP |           |           |       |       |
| К3  |            | 0.225 TYP |                       | 0.009 TYP |           |           |           |           |           |           |       |       |
| K4  |            | 0.355 TYP |                       | 0.014 TYP |           |           |           |           |           |           |       |       |
| L   | 0.175      | 0.275     | 0.375                 | 0.007     | 0.011     | 0.015     | 0.175     | 0.275     | 0.375     | 0.007     | 0.011 | 0.015 |
| T   |            |           |                       |           |           |           | 0.05      | 0.10      | 0.15      | 0.002     | 0.004 | 0.006 |

ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

06-Aug-07



# RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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ATTLICATION NOT



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Vishay

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